



# Product Change Notification

**Change Notification #:** 118830-00  
**Change Title:** Trusted Platform Module 2.0  
AXXTPMCHNE8, Single,  
PCN 118830-00, Product Design,  
Firmware update  
**Date of Publication:** January 7, 2022

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	February 04, 2022
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is upgrading the Trusted Platform Module (TPM) firmware from version 7.25 to 7.51 of the accessory listed in the "Products Affected" table below.

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Trusted Platform Module 2.0 AXXTPMCHNE8, Single	AXXTPMCHNE8	960608	J13111-005	J12350-150	J13111-006	J12350-151

## PCN Revision History:

<b>Date of Revision:</b> January 7, 2022	<b>Revision Number:</b> 00	<b>Reason:</b> Originally Published PCN
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## 118830-00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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